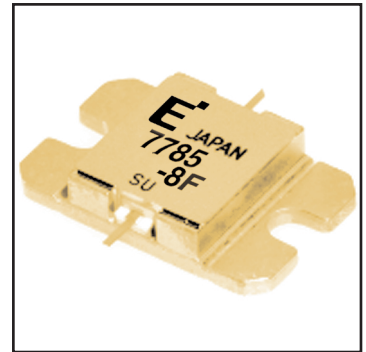


FLM7785-8F

C-Band Internally Matched FET

FEATURES

- High Output Power: $P_{1dB} = 39.5dBm$ (Typ.)
- High Gain: $G_{1dB} = 8.5dB$ (Typ.)
- High PAE: $\eta_{add} = 34%$ (Typ.)
- Low $IM_3 = -46dBc@P_o = 28.5dBm$
- Broad Band: 7.7 ~ 8.5GHz
- Impedance Matched $Z_{in}/Z_{out} = 50\Omega$
- Hermetically Sealed



DESCRIPTION

The FLM7785-8F is a power GaAs FET that is internally matched for standard communication bands to provide optimum power and gain in a 50 ohm system.

Eudyna's stringent Quality Assurance Program assures the highest reliability and consistent performance.

ABSOLUTE MAXIMUM RATING (Ambient Temperature $T_a=25^\circ C$)

Item	Symbol	Condition	Rating	Unit
Drain-Source Voltage	V_{DS}		15	V
Gate-Source Voltage	V_{GS}		-5	V
Total Power Dissipation	P_T	$T_C = 25^\circ C$	42.8	W
Storage Temperature	T_{stg}		-65 to +175	$^\circ C$
Channel Temperature	T_{ch}		175	$^\circ C$

Fujitsu recommends the following conditions for the reliable operation of GaAs FETs:

1. The drain-source operating voltage (V_{DS}) should not exceed 10 volts.
2. The forward and reverse gate currents should not exceed 32.0 and -4.4 mA respectively with gate resistance of 100 Ω .

ELECTRICAL CHARACTERISTICS (Ambient Temperature $T_a=25^\circ C$)

Item	Symbol	Test Conditions	Limit			Unit
			Min.	Typ.	Max.	
Saturated Drain Current	I_{DSS}	$V_{DS} = 5V, V_{GS} = 0V$	-	3400	5200	mA
Transconductance	g_m	$V_{DS} = 5V, I_{DS} = 2200mA$	-	3400	-	mS
Pinch-off Voltage	V_p	$V_{DS} = 5V, I_{DS} = 170mA$	-0.5	-1.5	-3.0	V
Gate Source Breakdown Voltage	V_{GSO}	$I_{GS} = -170\mu A$	-5.0	-	-	V
Output Power at 1dB G.C.P.	P_{1dB}	$V_{DS} = 10V,$ $I_{DS} = 0.65 I_{DSS}$ (Typ.), $f = 7.7 \sim 8.5$ GHz, $Z_S = Z_L = 50$ ohm	39.0	39.5	-	dBm
Power Gain at 1dB G.C.P.	G_{1dB}		7.5	8.5	-	dB
Drain Current	I_{dsr}		-	2200	2600	mA
Power-added Efficiency	η_{add}		-	34	-	%
Gain Flatness	ΔG		-	-	± 0.6	dB
3rd Order Intermodulation Distortion	IM_3	$f = 8.5$ GHz, $\Delta f = 10$ MHz 2-Tone Test $P_{out} = 28.5dBm$ S.C.L.	-44	-46	-	dBc
Thermal Resistance	R_{th}	Channel to Case	-	3.0	3.5	$^\circ C/W$
Channel Temperature Rise	ΔT_{ch}	$10V \times I_{dsr} \times R_{th}$	-	-	80	$^\circ C$

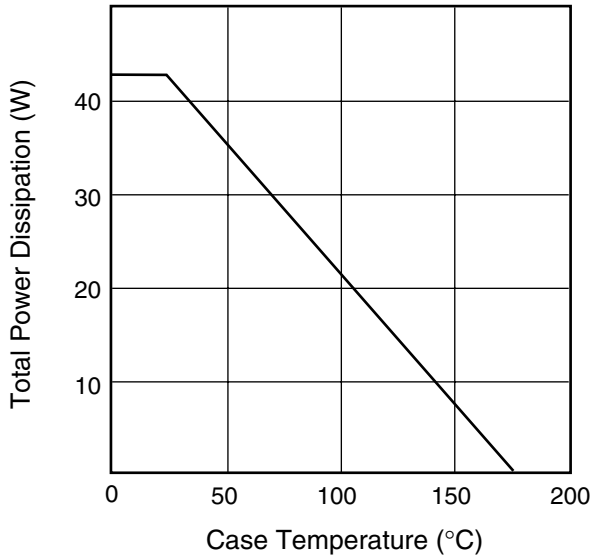
CASE STYLE: IB

G.C.P.: Gain Compression Point, S.C.L.: Single Carrier Level

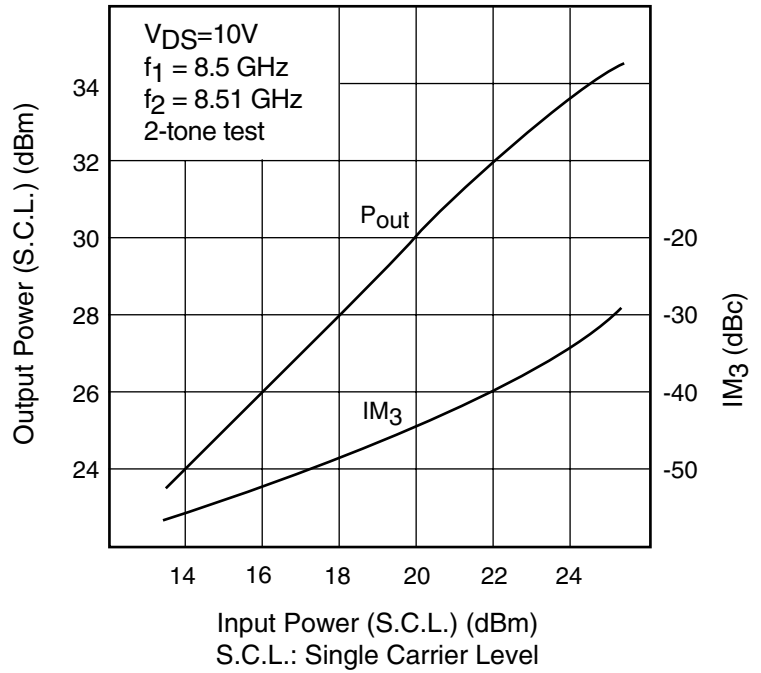
FLM7785-8F

C-Band Internally Matched FET

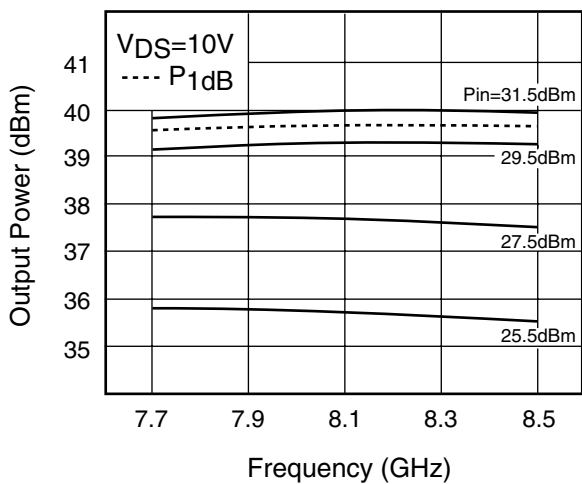
POWER DERATING CURVE



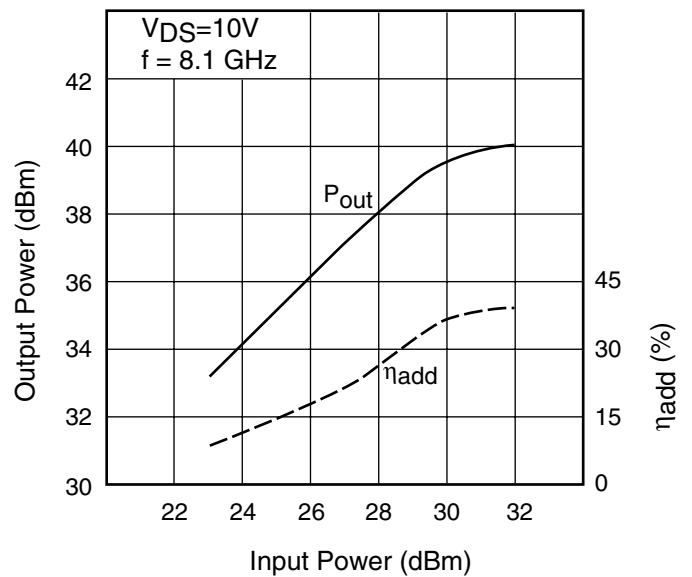
OUTPUT POWER & IM₃ vs. INPUT POWER



OUTPUT POWER vs. FREQUENCY

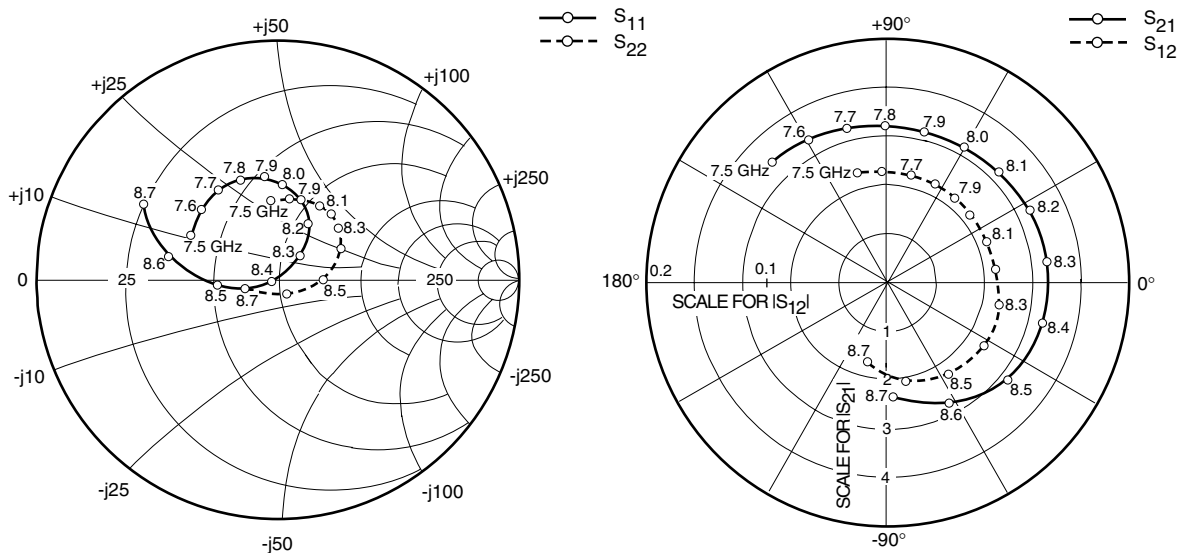


OUTPUT POWER vs. INPUT POWER



FLM7785-8F

C-Band Internally Matched FET



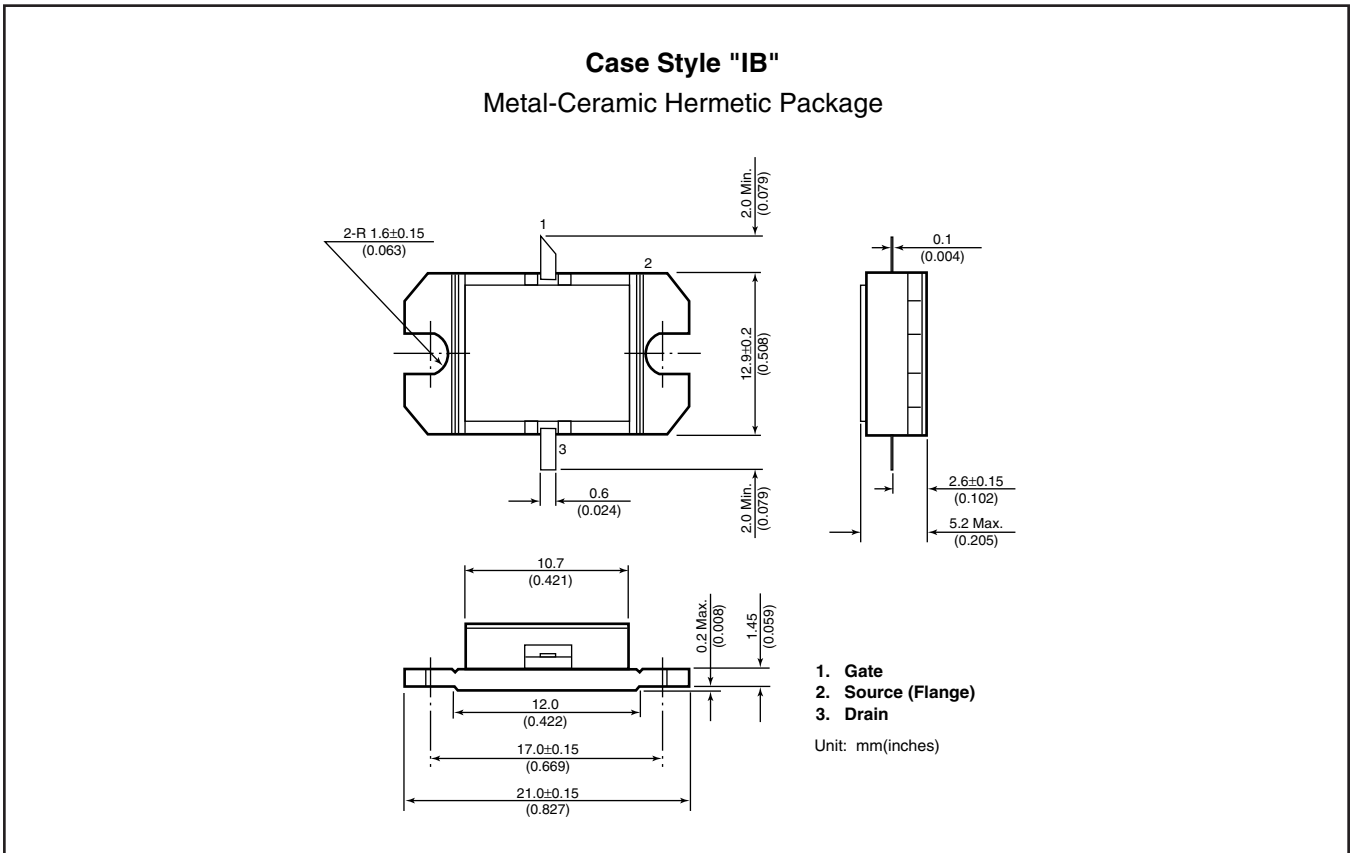
S-PARAMETERS

$V_{DS} = 10V, I_{DS} = 2200mA$

FREQUENCY (MHZ)	S11		S21		S12		S22	
	MAG	ANG	MAG	ANG	MAG	ANG	MAG	ANG
7500	.402	153.9	3.423	133.7	.094	106.1	.331	95.4
7600	.428	137.7	3.344	119.5	.091	93.1	.340	88.5
7700	.440	123.0	3.271	105.2	.090	79.1	.343	82.8
7800	.440	110.3	3.219	90.5	.089	64.6	.348	77.7
7900	.428	97.9	3.196	75.9	.088	51.4	.345	72.8
8000	.395	86.5	3.204	60.8	.087	39.0	.347	67.1
8100	.342	73.5	3.244	44.5	.088	21.9	.354	61.1
8200	.257	61.1	3.299	26.9	.091	6.3	.352	52.6
8300	.132	46.2	3.345	7.5	.093	-11.8	.331	41.7
8400	.038	-156.8	3.324	-14.4	.095	-33.4	.284	27.2
8500	.248	-171.2	3.168	-38.6	.091	-56.7	.186	0.0
8600	.462	169.6	2.817	-63.6	.083	-81.0	.069	-59.7
8700	.634	150.6	2.337	-87.2	.068	-104.4	.147	-164.2

FLM7785-8F

C-Band Internally Matched FET



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CAUTION

Eudyna Devices Inc. products contain **gallium arsenide (GaAs)** which can be hazardous to the human body and the environment. For safety, observe the following procedures:

- Do not put this product into the mouth.
- Do not alter the form of this product into a gas, powder, or liquid through burning, crushing, or chemical processing as these by-products are dangerous to the human body if inhaled, ingested, or swallowed.
- Observe government laws and company regulations when discarding this product. This product must be discarded in accordance with methods specified by applicable hazardous waste procedures.

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